

Appl. No. 10/563,778

Request for Corrected Assignment dated 10/19/2006

Attorney Docket No. 1217-053827

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/563,778 Confirmation No. 3140
Applicants : Naoya SAIKI
Filed : January 6, 2006
Title : Hardenable Pressure Sensitive Adhesive Sheet for Dicing/Die-Bonding and Method for Manufacturing Semiconductor Device
Art Unit : 1734
Customer No. : 28289

FACSIMILE NO. 703-305-9822

Office of Initial Patent Examination's

Filing Receipt Corrections

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

REQUEST FOR CORRECTED FILING RECEIPT

Sir:

Attached is a marked-up copy of the official Filing Receipt for the above-identified patent application for which a Corrected Filing Receipt is hereby requested.

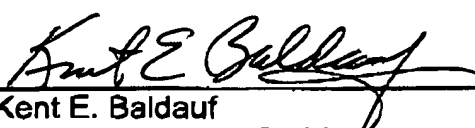
The Foreign Applications data is missing. It should include the following Japanese Application Information

--Japan 2003-271950 07/08/2003--

A copy of the Declaration and Power of Attorney for Patent Application filed with the application on January 6, 2006 listing the complete Foreign Priority Information is also attached. No fee is due, as there was no error on the Applicant's part.

Respectfully submitted,
THE WEBB LAW FIRM

By


Kent E. Baldauf
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Attorney for Applicant
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CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to U.S. Patent and Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450 on October 19, 2006.

Michael L. Vertullo
(Name of Person Mailing Paper)


Signature

10/19/2006
Date



UNITED STATES PATENT AND TRADEMARK OFFICE

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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/563,778	01/06/2006	1734	900	1217-053827		17	1

CONFIRMATION NO. 3140

FILING RECEIPT



OC000000019854061

Date Mailed: 08/02/2006

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Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Naoya Saiki, Saitama, JAPAN;

Assignment For Published Patent Application

Lintec Corporation, Tokyo, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 28289.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/09629 07/07/2004

Foreign Applications JAPAN 2003-271950 08/07/2003

If Required, Foreign Filing License Granted: 08/01/2006

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/563,778**

Projected Publication Date: 11/09/2006

Non-Publication Request: No

Early Publication Request: No

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AUG - 7 2006

Title

Hardenable pressure sensitive adhesive sheet for dicing/die-bonding and method for manufacturing semiconductor device

Preliminary Class

156

PROTECTING YOUR INVENTION OUTSIDE THE UNITED STATES

Since the rights granted by a U.S. patent extend only throughout the territory of the United States and have no effect in a foreign country, an inventor who wishes patent protection in another country must apply for a patent in a specific country or in regional patent offices. Applicants may wish to consider the filing of an international application under the Patent Cooperation Treaty (PCT). An international (PCT) application generally has the same effect as a regular national patent application in each PCT-member country. The PCT process **simplifies** the filing of patent applications on the same invention in member countries, but **does not result** in a grant of "an international patent" and does not eliminate the need of applicants to file additional documents and fees in countries where patent protection is desired.

Almost every country has its own patent law, and a person desiring a patent in a particular country must make an application for patent in that country in accordance with its particular laws. Since the laws of many countries differ in various respects from the patent law of the United States, applicants are advised to seek guidance from specific foreign countries to ensure that patent rights are not lost prematurely.

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Applicants may wish to consult the USPTO booklet, "General Information Concerning Patents" (specifically, the section entitled "Treaties and Foreign Patents") for more information on timeframes and deadlines for filing foreign patent applications. The guide is available either by contacting the USPTO Contact Center at 800-786-9199, or it can be viewed on the USPTO website at <http://www.uspto.gov/web/offices/pac/doc/general/index.html>.

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Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15

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(SF-1069a)

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Declaration and Power of Attorney for Patent Application

English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled DICING AND DIE BONDING PRESSURE-SENSITIVE ADHESIVE SHEET AND PROCESS FOR PRODUCING SEMICONDUCTOR DEVICES

The specification of which

- ☐ is attached hereto.
- ☐ was filed on _____
as Application Serial No. _____
and was amended on _____
(if applicable)
- ☒ was filed as PCT international application
No. PCT/IP2004/9629 on July 7, 2004
and was amended under PCT Article 19 on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed	
<u>2003-271950</u> (Number)	<u>Japan</u> (Country)	<u>08/July/2003</u> (Day/Month/Year Filed)	<input checked="" type="checkbox"/> Yes	<input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

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(Application Serial No.)

(Filing Date)

(Status)

(patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status)

(patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the practitioners associated with

Customer Number 28289

to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith.

Customer Number 28289 identifies the law firm of **WEBB ZIESENHEIM LOGSDON ORKIN AND HANSON, P.C.** whose address is 700 Koppers Building, 436 Seventh Avenue, Pittsburgh, Pennsylvania 15219-1818, Telephone No. 412-471-8815

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Please direct all telephone calls to Kent E. Baldauf, at telephone number (412) 471-8815.

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Inventor's signature	
Date	
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(W0175174.1)